

FORM PTO 1449 (modified)  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary)		ATTY DOCKET NO. <b>00839.000419.1</b>		APPLICATION NO. <b>10/656130</b> <del>09/264,499</del> Div of Appl. No.	
APPLICANT		<b>MAKOTO HIGASHIKAWA ET AL.</b>			
FILING DATE		<b>Herewith</b>		GROUP <b>Unassigned</b> <sup>1763</sup>	

  

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
<i>WOF</i>	6065425	05/00	Takaki et al.	118	723		
<i>WOF</i>	5652029	07/97	Itoh	427	569		
<i>WOF</i>	5766696	06/98	Itoh	427	577		
<i>WOF</i>	4400409	08/83	Izu et al.	427	39		
<i>WOF</i>	5677236	10/97	Saitoh et al.	437	578		
<i>WOF</i>	4492736	01/85	Tanner	427	578		
<i>WOF</i>	4600801	07/86	Guha et al.	427	74		
<i>WOF</i>	6100466	8/00	Nishimoto	427	588		
<i>WOF</i>	5720826	02/98	Hayashi et al.	427	575		
<i>WOF</i>	5362684	11/94	Saito et al.	427	575		

  

FOREIGN PATENT DOCUMENTS							
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO/ OR ABSTRACT	
<i>WOF</i>	JP 9-256160	1997	Japan			Corresp. to USP 6,065,425	
<i>WOF</i>	JP 59-213176	1984	Japan			No	
<i>WOF</i>	JP 2575397	1997	Japan			No	
<i>WOF</i>	JP 57-195737	05/81	Japan			Eng. Abst.	
<i>WOF</i>	JP 59-213176	05/83	Japan			Eng. Abst.	
<i>WOF</i>	JP 3-6466	01/91	Japan			Abstract	
<i>WOF</i>	JP 62-57710	12/87	Japan			Abstract	

  

OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)	
<i>WOF</i>	R. Flukiger, et al., "Preparation of Undoped and Doped Microcrystalline Silicon ( $\mu\text{c-SiH}$ ) by VHR-GF for P-I-N Solar Cells, 23 <sup>rd</sup> IEEE Photovoltaic Specialists Conference, 1993 (pp. 839-844).

  

EXAMINER <i>Maureen Drancovic</i>	DATE CONSIDERED <i>09/02/2005</i>
-----------------------------------	-----------------------------------

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 809; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

369849

Sheet 1 of 2

